

As a below named inventor, I hereby declare that:

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ΠJ

Post Office Address:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled DEVICE AND METHOD FOR PROTECTING AGAINST OXIDATION OF A CONDUCTIVE LAYER IN SAID DEVICE, the specification of which:

X is attached her		specification of which:	
	, as Applic	ation Serial No	
I hereby state that including the claims.	I have reviewed and	understand the contents of the	e above identified specification,
I acknowledge the claimed in this application Regulations, § 1.56.	duty to disclose info as "materiality" is defi	rmation which is material to paned in Title 37 of the Code of Fe	tentability of the subject matter deral
not disclosed in the prior U United States Code, § 112	de, § 120 and, insofar inited States application, I acknowledge the decode of Federal Reguler attional or PCT interpretation.	as the subject matter of each of in the manner provided by the uty to disclose information which ations, § 1.56 which became ava	o which I am entitled under Title the claims of this application is first paragraph of Title 35 of the ch is material to patentability as allable between the filing date of
(Application Serial	No.) (Filing	Date) (Status)	
Send correspondence to:	•		
	Charles B. Brantley Micron Technology 8000 S. Federal Wa Boise, Idaho 8370 (208) 368-4557	y, Inc. sy	•
that willful false statemen	believed to be true; a ts and the like so mad ode, § 1001 and that s	nd further that these statements e are punishable by fine or imp	and that all statements made on were made with the knowledge prisonment, or both, under Title by jeopardize the validity of the
Full name of first or sole in 1 Inventor's Signature: Date: 11 24 98	(First, Middle Intit	I, Last)	
Residence Address: City, State, Country:	A303,2382 E. Red Boise, ID 83716	Cedar Lane] United States of America	
Citizenship:	India		

Same as residence address